



Rapid prototyping: Creating a minimum viable product using a single-board microcontroller

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<p>Abstract:</p> <p>This thesis explores the minimum viable product development technique, most often used in software development, as an alternative product development technique when making a physical product. A literature review is done on additive manufacturing, minimum viable product and single-board microcontrollers.</p> <p>As an experiment a simple concept is developed, and a market validation is performed. A prototype is made from that concept and then iterated upon and the iteration process is documented. The result is a functional minimum viable product which then can be the basis for further studies.</p> <p>The results of the experiment are evaluated, and issues with it are brought forward. Further research is theorized, including how the product journey continues from the prototype stage to production prototyping, and how the product journey was for successful companies and companies that failed in being sustainable. Four new key principles are introduced, derived from the literature and experiments, as guidelines to create more sustainable development and a more streamlined development process.</p>	
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<p>Sammandrag:</p> <p>Detta slutarbete undersöker ifall produktutvecklingsteorin ”minimum viable product”, som oftast används inom programvaruutvecklingsindustrin, kan används för att utveckla fysiska produkter. En litteraturöversikt görs över friformsframställning, minimum viable product och mikrokontrollerkort.</p> <p>Ett experiment genomförs för att utveckla ett koncept, vilket leder till en marknadsundersökning. Konceptet produceras med friformsframställning och itereras tills resultatet är nöjaktigt, och processen dokumenteras. Konceptet blir färdigt som en minimalt fungerande produkt, på vilket vidare studier kan baseras.</p> <p>Experimentets resultat går igenom, och problem som dyker upp adresseras. Vidare forskning kunde innehålla hur konceptet tas från prototyp till produktionsfärdighet, och hurdana produktresor andra företag har haft med lyckade och misslyckade produkter. Fyra punkter introduceras, härledda från litteratur och erfarenhet med experimentet, vilka fungerar som hjälpmedel i produktutvecklingen.</p>	
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1 INTRODUCTION

“Hardware is hard” is a cliché within the startup communities, repeated as often as new hardware companies go under, but as old clichés go, they are usually based on some truths. The working capital of creating a physical product is so much larger than writing software or offering services, because of the costs involved in mass producing anything, and the obligatory steps needed before even getting to the mass production phase, which already puts hardware in a tougher spot. Even with new services provided for companies to promote and judge the demand for their products, services like Kickstarter and Indiegogo, a lot of entrepreneurs have tried to solve the startup hardware problem, but on multiple occasions have they acquired numerous pre-orders and gained much publicity only to suddenly fall short of their intended target. And even if the company manages to get angel investors to invest in the product, the statistics are still grim; Up to 70% of companies that receive investments fall through [1].

The increase of network-connected devices and the general trend of Internet of Things creates the demand for companies that try to solve the issue of prototyping complex circuitry and networking. Instead of manually assembling circuit boards in a garage, these companies sell small single-board microcontrollers that include modern communications technologies that allow for quickly going from idea to product, without needing to have premade contacts at manufacturers [2]. This insurgency of easy-to-learn microcontrollers and the rapid success of 3D printing is creating a much quicker iteration process than ever before.

The purpose of this thesis is to examine the product development technique, minimum viable product, and research if it can be applied to physical products. The thesis tries to answer three main research questions on this topic:

RQ1: Can the product development technique “minimum viable product” be used for hardware projects in the same manner as it is used for software projects?

RQ2: What are the available tools for making a small hardware project?

RQ3: How do you iterate on hardware?

The interest of additive manufacturing has improved as of late which makes it the natural selection for the manufacturing method of this thesis. Single-board microcontrollers have

created a market segment where the point of entry into making an electronics-based product is so much easier than any other option that it is chosen for this thesis.

As such, in the literature review the state of additive manufacturing is reviewed, and three main methods are focused upon. The minimum viable product development technique is inspected from a general view, as written by its inventors and as used in the software industry, then separately from a hardware view which is more experimental. Single-board microcontrollers are reviewed, and a single microcontroller family is selected as the main focus point.

As a proof of concept, a concept of product is made and iterated upon until a working prototype is complete, and the next steps are considered. Since the creation of a product is such a vast effort, the scope of the proof of concept has to be well defined and limited, to create a safe space for experimentation and iteration to occur, without too much thought on viability in the long run. As such the development is stopped as soon as the product is usable in its simplest state.

The process of creating a prototype and a product is then discussed and further research is suggested. Four principles are introduced for developing products to improve success rate.

2 LITERATURE REVIEW

This section contains the literature review for additive manufacturing, minimum viable product, and single-board microcontrollers. Additive manufacturing is a very broad area, with a lot of different production methods available, and in order to limit the scope of this literature review only three main methods are covered in detail, and as limitations to access to particular technologies will force the method to work around fused deposit modelling, interest lies in covering that particular method in even finer detail. Furthermore, there are also equally many different single-board microcontrollers, but since the LightBlue Bean, which offers Bluetooth connectivity and a set of features that are appropriate, will be used in this project, this review will focus on the Arduino family (which the Bean is based on) and the LightBlue Bean.

2.1 Additive manufacturing

In their core principles, most additive manufacturing (known also as rapid prototyping or even more familiar for consumers as 3D printing) methods mostly work in the same way. In order to create a three-dimensional piece, a computer program slices the 3D-model into layers, which then can be fed into the driver for the printer. The driver then creates the G-code for the path the printer will take to print each layer on top of each other, and the piece is printed. But as simple as it sounds, each method offers different solutions for the common issues met when printing. [3]

The first issue is how accurately the method can reproduce the model in real life. Even though these pieces usually are made for prototyping purposes, where standards are a little looser, the accuracy of the printer still limits the detail that can be reproduced. If the piece is small or relies on some very thin or small features, it might be hard to produce it with a 3D printer. [4]

The second issue is how fast it will manufacture the piece. The speed of which you can make a prototype might limit the rate you can develop products. This is usually also a trade-off between the first issue and this one. Faster printing usually will lead to worse results, while going slower might increase the accuracy the printer will achieve. [5]

Lastly, if a piece has a difficult geometry or has overhanging parts. This also touches on the first issue, but in a different way. If you are trying to create a lip for a product, you cannot just lay a layer of material on thin air, instead, you need to either rotate the piece

so that the geometry is supported by something or add temporary supporting structures to the part you are printing. Modern software will add these structures for you, but they might add printing time, and blemishes to the printed piece. These blemishes can, of course, most of the time be removed in a post-processing process using either a physical or chemical removal of material, but this adds to the time needed to get the finished piece ready for testing. This process can become hard to understand without experiencing them first hand, as when modeling an object in a computer program, there are no gravity or weight, so any shape is possible, but when that object is then made in the real world, unexpected errors may happen if no design considerations are made. [5]

2.1.1 Stereolithography

Stereolithography (SLA) is an additive manufacturing method patented in 1984 [6] and was the first modern 3D printing method developed [7]. It is designed to use UV-light to cure layers of a liquid resin on top of each other creating a three-dimensional piece. SLA was a response to a multi-beam system wherein the resin was cured in three-dimensions within the resin but was lacking in accuracy and exposure control and created complex control situations when the focus spot was deeper in the liquid resulting in less than desirable results [6].

The material used in an SLA apparatus is an ultraviolet (UV) curable resin (also known as photopolymers), which is then exposed to a UV-beam, which cures the resin in a layer. The layer is then either lowered or is raised, depending on the machine and the process. The right side up method is usually used in larger scale industrial machines, which require more maintenance, has larger resin baths and can print larger objects, and introduces less stress on the object as it is sunk into the resin as the layers progress. The alternative is then the inverted method where the resin bath is only a fraction of the right side up method, and the resin then cures on a nonstick surface on the bottom of the resin bath and is then separated and lifted out of the bath. This will produce more stress on the part as it is lifted in the air but requires much less maintenance and initial resin and such is more suited for the consumer, but the object size limitations are much smaller than the right side up method. [8] The use of photopolymers means that there are limited amounts of variations in the material compared to other manufacturing methods, and due to the nature of the curing of the resin, the resulting pieces also inclined to become brittle in

sunlight and UV exposure [9]. During the curing process for the layer, the polymerization reaction is not completed, which results in that the printed part is isotropic, meaning that the layers also form covalent bonds with the next layer, giving the piece uniform mechanical properties, independent of the direction of the force, and also a cleaner visual with a lack of visible printing lines [8].

When designing the object, and planning for manufacturing using SLA, the inverted printing process' separation stage produces high amounts of stress on the object, so large Z-axis cross-sectional areas will be under considerable stress. In order to reduce this issue, the piece can then be rotated at an angle, minimizing the stresses. This then produces the need for additional supports to hold the object at the correct position, so careful consideration has to be taken when deciding if SLA is the optimal method. The accuracy of an SLA print can go beyond what the Fused Deposit Modelling method is capable of, with SLA achieving an accuracy between 25 and 200 microns. [10]

Stereolithography was the first commercially available rapid prototype method, released to the public in 1988, by 3D Systems, Inc [11], and they have continued to produce and develop different 3D printing systems for industry and consumers.

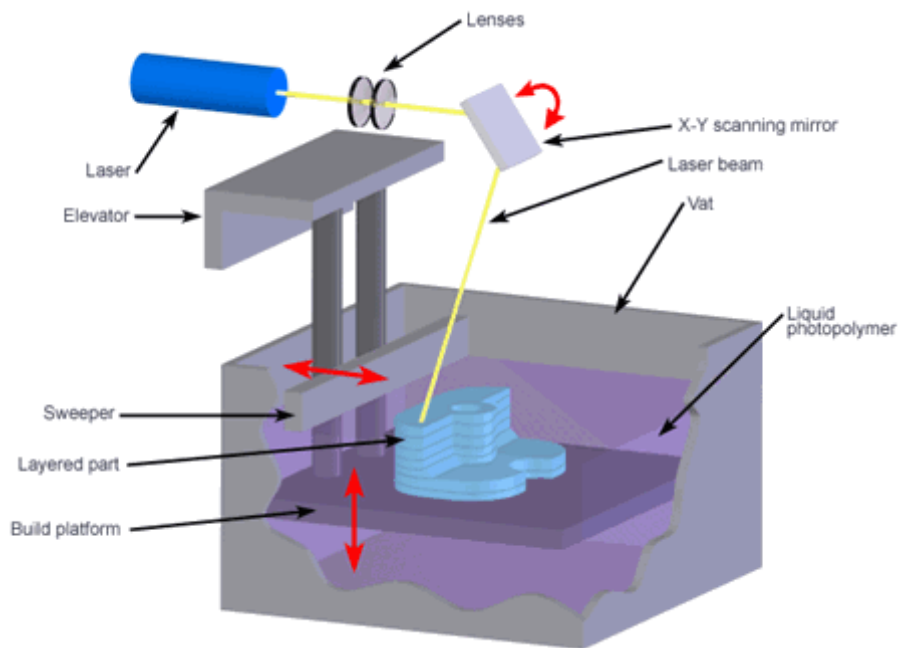


Figure 1: Stereolithography diagram [5]

2.1.2 Selective laser sintering

Sintering, as defined by the Encyclopaedia Britannica: “the welding together of small particles [...] by applying heat below the melting point” [12]. The method was developed at around the same time as SLA, and selective laser sintering (SLS) functions in a similar manner. Instead of a basin of liquid resin, the material used is in a pulverized form. The powder is sintered according to the layer using a high-powered laser, whereafter, the platform is lowered, and another thin layer of powder is spread over the platform, and the next layer can be sintered. This has the significant advantage that no support structures are needed for overhanging parts or similar problematic geometry since the surrounding powder will support the full structure at all times. Sintering also allows for a wider range of materials, including metals and ceramics. The remaining powder after the pieces is finished can also be reused, so although the initial material usage is high, most of it will be used in the end. [13]

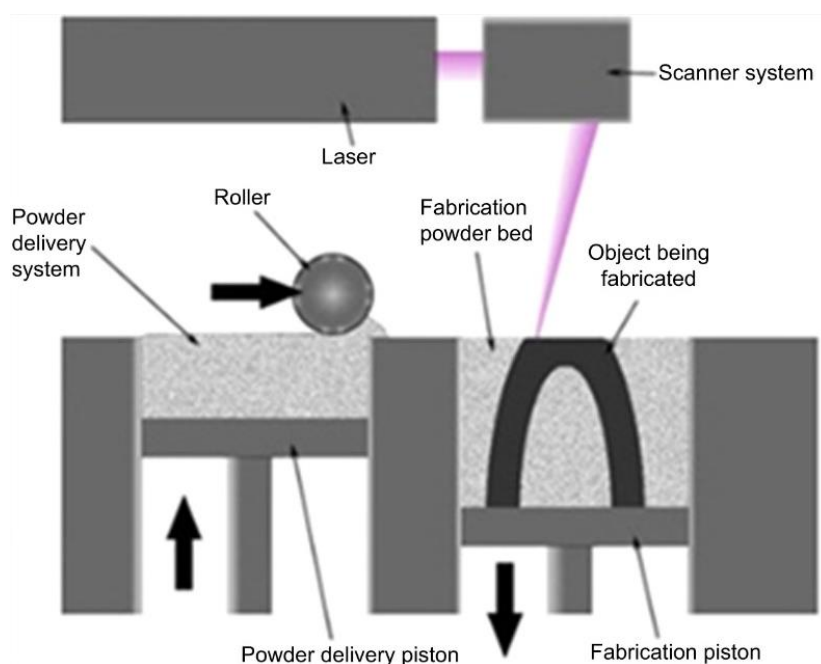


Figure 2: Selective laser sintering diagram [14]

The downside of SLS is that you cannot print fully enclosed but hollow parts, since the powder will then be trapped inside the part, thus a drain hole is always needed. Another issue for affordable printers for the public is that the heating and melting of the powder must be accurate up to 2 degrees Celsius which is hard in non-commercial settings [15].

The high temperatures needed to sinter the object also may contribute to some warping of the piece, especially for large flat surfaces, and most pieces experience a shrinkage which must be taken into consideration before starting the print [16]. The surface finish is also very porous and rough when printed and requires more post-processing than other methods if the piece is to be as smooth as a similar part printed using SLA [17].

2.1.3 Fused deposit modeling

(FDM) is the most popular rapid prototyping method currently on the market [18]. The term FDM was coined by Stratasys, Inc. in 1989 [19] and the company has also produced FDM printers to the market since then.

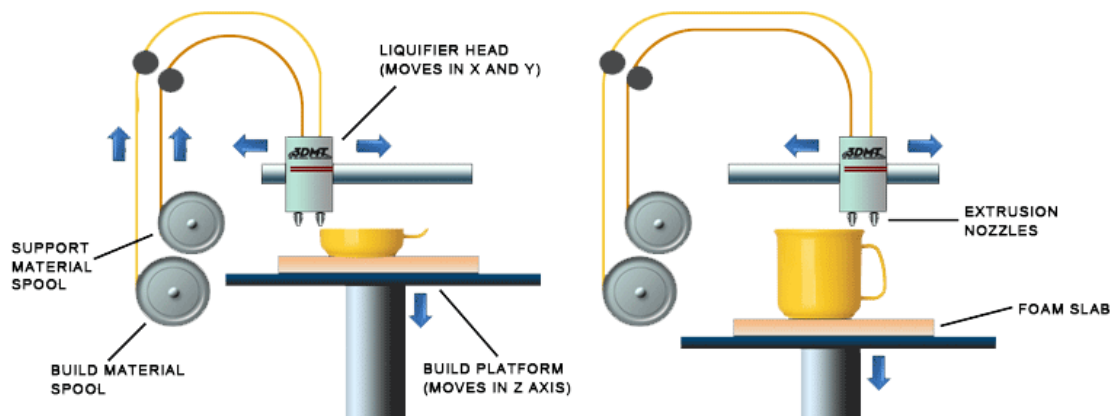


Figure 3: Fused deposit modeling diagram [20]

Unlike SLA and SLS, fused deposit modeling works by extrusion. A filament wire of thermoplastic is lead through a liquefier, usually by means of a roller controlled by a stepper motor, which then pushes the material out of a small nozzle, fitted on a head which can move in 3 directions. Once the material is out of the nozzle it will cool rapidly, since the build platform the liquid material is pushed on is of much lower temperature. This way, the machine can lay out a layer of material on top of the platform and rapidly lay the next layer on top. The simplicity of the system has pushed its popularity to the consumer markets, and various open-sourced versions of this system are available to build online [21]. Since there are no liquid baths or powders that need to be applied the FDM requires a very minimal amount of mechanical properties, and most of the difficulties lie in the X-Y-Z coordination and accuracy of the nozzle [4].

As the matter is extruded out of a nozzle, some geometry is especially disadvantageous, and the solutions to those are often not as elegant. If there is a gap between two points

and a bridge connecting the two points, the lower layer will not hold up itself and will start to sag. Rotating the part might fix the issue or splitting the part into two and gluing the two parts together in post-processing, but some designs make the gap inevitable. The other options include making the gap smaller to lower the risk of the sagging occurring, but the only way to be sure is to use supports, which then can leave hefty marks on the finished surface, or even potentially damage the surface. [22]

Another issue is that as the nozzle extrudes material, it also slightly forces it onto the lower layer, which causes the layer to be compressed into a more oval shape. This is especially notable on the foot of the part, where it might create a flare out from the part, and also in vertical holes, which are then undersized per the original design, as the diameter of the extrusion exceeds the expected diameter. The issue of adhesion also is visible in overhangs, where the limit is around 45 degrees, as above it less than 50% of the material will be supported by the layer underneath, and the quality loss and the thin lip then deform from the heat applied to the material. [22]

The accuracy of FDM suffers from the fact that it cannot be more accurate than the bead of extruded material that comes out of the nozzle. The bead also limits the corners of the print to be rounded and can never be perfectly square. Warping occurs as well, again on large flat surfaces. Compared to SLA the finished piece also won't be isotropic, but anisotropic, meaning that the direction of the force and the way the piece is layered will affect its mechanical strength.

2.2 Minimum viable product

Minimum viable product (MVP) is a product development technique most often used in software development, which was first introduced by Frank Robinson in 2001 [23]. The concept is that instead of creating a full-fledged product, you create something that is working but not finished and then sell that to fund the rest of the development [24]. It is a rapid development technique that results in a much quicker feedback loop with the customers and an easier start to the product development. The term minimum is not a set amount in this case, but more a guideline to judge. It refers to the next word, viable, in the sense that something has to be viable in order to sell, one could even think of viable and sellable being interchangeable. The translation of the term then becomes: The

minimum amount of work needed to create a product that someone else would want to buy.

Eric Ries calls the early adapters for “visionaries” [24], in which that they see the product not as it is in its early stage but what it could become. These visionaries are more likely to accept a subpar product and more willing to give feedback to the developers that can then be used to improve the product. The selling point behind MVP is that the iteration and feedback from the visionaries can help to avoid building something that the customers do not want, and minimizes time spent on something that will not sell [25]. The product thus creates some sort of value to its customers adding meaning and targets to develop for. Ries calls this the value hypothesis, which Münch et al. [26] explains as:

In Lean Startup terminology, a value hypothesis and a minimum viable product (MVP) need to be developed. Following Ries, a value hypothesis “tests whether a product or service really delivers value to customers once they are using it”. An example of a value hypothesis is that customers of a specific customer segment will choose to sign up for a service based on a given set of features being offered.

The MVP created is then tested against this value hypothesis and evaluated for improvements and iterations.

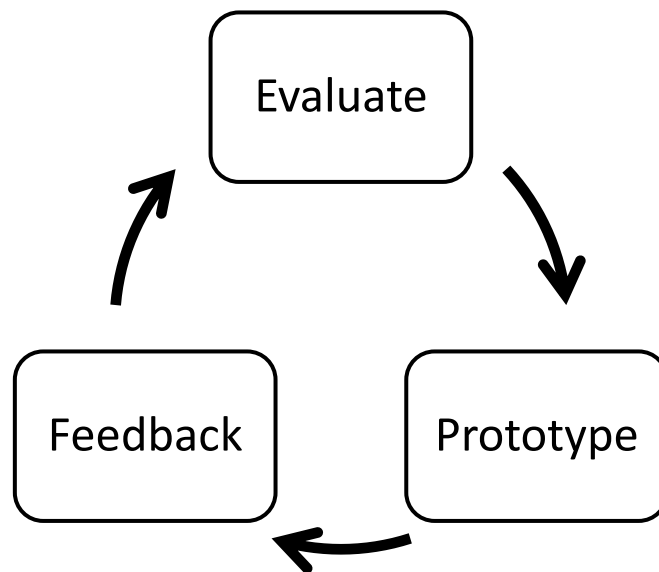


Figure 4: The iteration circle in MVP

A relevant example of MVP in action is within game development. Within the recent years there has been an increasing amount of so-called “early-access” games, where the company sells the product when the game is its infancy stage, and barely playable, and then with the continuous feedback received from the customers then can adopt it into their development roadmap. What started with minimal development teams showing of ideas

and asking for small, under five euro, payments have then transitioned to larger teams with bigger visions selling products for over thirty euros. People are more than willing to be the visionaries for these games and prove a loyal fan base as well. [27] [28]

A commonly used technique for testing a value hypothesis is to do A/B testing [24]; In which you have two different designs or theories, and by implementing both and testing them against each other, you gain valuable knowledge about what the customers want and how they react to each hypothesis.

An example where it is commonly used is with web applications. It is easy to create two separate calls for action, with different colored buttons and then randomly present each of the versions to users. You can then gather data on which button then generates more clicks and affirmative actions on the site. [29]

2.2.1 MVP and hardware

The Cambridge dictionary defines hardware as “the physical and electronic parts of a computer, rather than the instructions it follows” [30]. Applying then the previous points to hardware product development requires rethinking. The fluid nature of software development does not translate to the engineering and production it takes to create something physical. The delays from the engineering department to factory can extend over days and prototyping often requires manual labor, and any mistakes made in the shipped product cannot be patched at the destination of the product, resulting in that companies have to be more careful in shipping. The production also requires much more capital for each production run than any software release, so the barrier to entry is already very high.

Marc Barros states that “The key to a great hardware MVP is focusing on a single feature [...] and getting to market quickly” [31]. Focusing on one single feature that defines the product creates a solid base to refine on, and to expand upon when needed. Barros argues that the most refined products today start as something simple and focused and has evolved into the well-executed and stylish product over time.

A/B testing within hardware is not as easy as with software. You cannot present a random design to a user of your product since they buy that specific product. Therefore, you must introduce all the testing in the prototype stage and try out fewer designs, and with fewer

customers, which might introduce some uncertainties in the design. Thus, focusing on one singular feature might then create an easier focus in the prototyping phase.

Barros also states that when the first product is produced, it is not in any way the final state, but that then with the influx of customer feedback (indirect or direct) the iteration process should continue, and a new and improved product should be produced within a year. He also states that breaking the product into multiple parts will simplify the development of the final goal. [32]

2.3 Single-board microcontrollers

Microcontrollers are essentially complex circuitry miniaturized to the size of one chip, made possible by the rapid advancement in transistor development. In the 1980's manufacturers started to introduce microprocessors instead of logical circuits, in order to reduce costs and improve the possibilities of the electronic products, as circuits could then be replaced with a few lines of code. These microprocessors needed additional external chips to do anything useful, so in the 1990's the manufacturing techniques had advanced even further, allowing for more consolidation of chips under one hood. These new chips then came to be called microcontrollers, as they could handle complex logical structures and inputs all without external support. [33]

Essentially then, microcontrollers are resource-poor computers; If a modern desktop computer or laptop is a general-purpose machine for everyday use, then a microcontroller is a highly specific machine, very capable at whatever task it is instructed to do but cannot multitask at the same level as a larger computer. They are well suited for automated tasks, and can even integrate analog signals into the system, communicating with non-digital systems. [33]

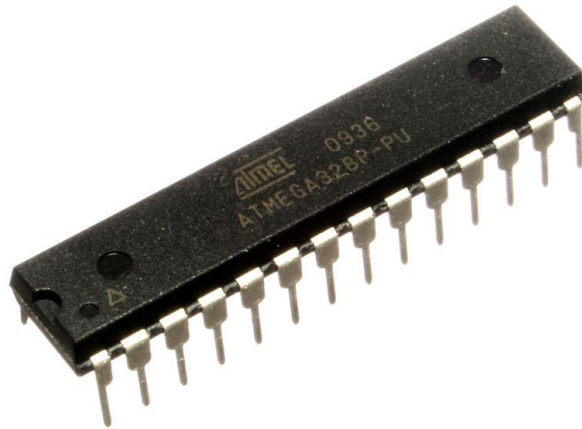


Figure 5: ATMega328 Microcontroller [34]

A single-board microcontroller takes the concept even further and embeds all useful circuitry required to communicate with different systems, with the intention that the board is immediately usable for most people. A microprocessor usually already has all the required specifications, but development boards are made where all the input and output pins of the microprocessor are wired on to a larger board using larger components (like pin connectors and even USB) so that the barrier of entry is as small as possible. These boards are usually not meant for direct use in products, but as a stepping stone into figuring out what is needed, and quickly testing an idea. What separates the single-board microcontroller from a single-board computer is that it is not a full-bodied computer, it lacks the processing power to run an operating system and a program. Instead, it runs the program straight from memory, reducing power requirements for the board by a fair margin. In some cases, the programming knowledge required is even reduced, by enabling higher level programming languages to be used in the system. The systems are usually low-cost, which also makes it ideal for educational purposes. [35]



Figure 6: Arduino Uno [36]

2.3.1 Arduino project

Arduino is an open source company and community, started in 2003 as a concept to bring low-cost devices that could interact with the environment using different sensors and actuators. It was intended as a low barrier to entry into programming hardware. As the community grew, the capabilities of the microcontrollers also grew, and now the board is available in multiple sizes and configurations, to suit the intended applications even better. With wireless technologies, and the concept of IoT (Internet of Things, stating that using the internet, common devices not intended to communicate can suddenly try to optimize their performance using data from all over the internet), the Arduino platform grew into a standard for fast prototyping ideas. [37]

Most of the Arduino products run on the Atmel 8-bit AVR microcontroller family [38], and the boards have different inputs available, mostly through either single or double-row pin connectors, to which “shields” can be attached for example. These shields are expansion circuit boards that provide the Arduino with more external input and output solutions, e.g. for controlling DC motors [39].

2.3.2 LightBlue Bean

The LightBlue Bean (LBB) is an Arduino-inspired single-board microcontroller made by Punch Through Design [40]. It is specifically designed as a small, low-energy wireless node, that can communicate wirelessly with devices using Bluetooth technology, and it contains a multitude of sensors and operates on small batteries. The LBB works as a

stepping stone between customized circuitry and prototyping, with the company making the product then selling their production consultation services [41]. With the board being much smaller than the original Arduino boards, the circuitry can be much easier integrated into products, and though it is missing many of the features of the original board, it fills the niche of the developing wireless IoT market.

The LBB uses an ATmega328p microcontroller, and a Texas Instrument CC2540 Bluetooth SoC (system-on-chip). The CC2540 controls the Bluetooth communications, separately from the microprocessor, which adds a layer of security when programming, as it makes it impossible to render the microprocessor unusable. The board also has 2 analog I/O (input/output) pins and 6 digital I/O pins available, and a small board where components can be soldered on. [40]

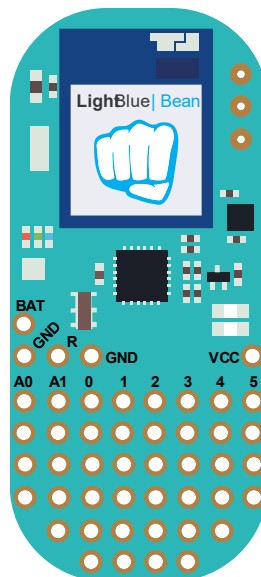


Figure 7: A render of the LightBlue Bean, with pins written out. The large blue block is the Bluetooth chip and the black block underneath is the microcontroller. [42]

3 METHOD

In order to answer the research questions stated in the introduction a product is conceptualized and then prototyped. A concept of a simple remote camera trigger is created, and market research is done. The LBB functions as the workhorse of the product, and a case is printed using FDM, and the design choices are then iterated upon to improve the product. The final functional prototype is then produced and presented.

This section contains 4 parts:

1. Proof of concept
2. Designing the product
3. Iteration process
4. Production

3.1 Proof of concept

Older digital single-lens reflector cameras (DSLR) can be triggered remotely either through wires or by using a proprietary wireless receiver and remote trigger from the DSLR manufacturer. In most cameras, the actual wiring for triggering a camera is very archaic; shorting two pins in a connector will release the shutter on the camera. Any remote trigger is either using this method with infrared signals to signal the trigger or connects digitally to the camera. Using modern wireless communication methods with the simpler triggering method can result in creative new ways to look at older camera equipment that lacks the digital control interface. Creating a mobile interface to communicate with a microcontroller over Bluetooth enables interesting options for very fine manual control of the shutter release. The Bluetooth connection makes it possible to be up to 10 meters from the camera, behind cover, and still, operate the camera. Combining this with a wirelessly enabled memory card, you could potentially even get your pictures from the camera without even touching it. This concept could then be used as a method for elongating the life of these older cameras.

As seen in figure 8, the concept is that a mobile device connects to the microcontroller, and the user can then send a data packet from the mobile device that then the microcontroller interprets and sends the signal to the camera to take a picture. It is not a

circular system where the user then gets any data back from the camera, but a one-way lane from the mobile device to the camera.

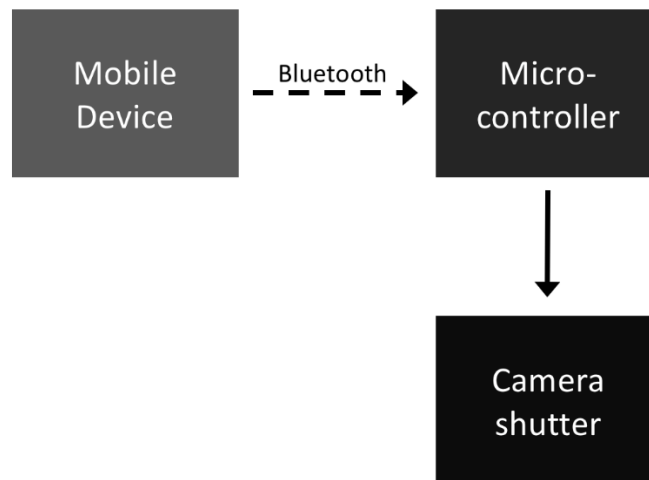


Figure 8: The basic concept of the Bluetooth controller remote shutter. A data packet is sent from the mobile device to the microcontroller, which then shorts the two wires to trigger the camera shutter

3.1.1 Market validation

As market research, or validation would in its most extensive case require an in-depth analysis of the customer segment, and that is much beyond the scope and time allotted for this experiment, a SWOT (Strength, Weakness, Opportunities, and Threats) analysis will be used instead. By performing the SWOT analysis (Figure 9), the market for the product can be estimated roughly. The method is often used as a quick and cheap way of quickly generating an estimation of what to expect when taking a step into something new, and sometimes as a re-evaluation of the current state.

The strengths of this product would be that it is small, customizable and cheap. The small frame and low level of intricacy allow for the battery to potentially last much longer than the competitors. If inclined, one could also programmatically trigger the camera, and use cameras in new creative ways.

The weaknesses could be that it is a late starter in the wireless adapters for cameras. Other products already exist and are more inclined to control the camera from within, rather than external triggering the camera using more archaic ways. It does not feature any transferring opportunities for pictures, or any deeper communications with the camera.

Even if this product never makes the market, it could always thrive as an open source alternative that people who are inclined to take on small projects could use and iterate on.

It also has an advantage in that it can be modified for any camera, digital and analog, as long as the triggering mechanism is known. This could be of use for people that use older models of cameras, but still wants or needs some wireless capability.

There are two similar products on the market, both within their own niche; One is a crowdfunded project that tries to bring machine learning to help the customer take photos, the other a more traditional version that focuses more on enabling the wireless experience. Both make use of the USB connector on the camera and look like they have a larger microcontroller inside them. They claim to have a 6-hour battery life and use both Bluetooth and Wi-Fi to communicate with a phone or computer. Both products are priced between 150 and 200 dollars.

Arsenal states on their website that their dongle is an “intelligent assistant for [...] cameras”. They focus more on the software experience and how it can use machine learning to help the user take a photo. They also enable file sharing from the camera to the phone and onwards. Their target group is for the high end of amateur photographers, helping them to become better. [43]

The Case Air focuses more on the professional market, as an extension of their other products that already target professional studios. They also offer wireless control of the camera, but with more focus on the user controlling, than an artificial intelligence. [44]

<p>Strengths</p> <ul style="list-style-type: none"> • Customizable • Small • Cheap 	<p>Weakness</p> <ul style="list-style-type: none"> • Late to market • Archaic controlling interface
<p>Opportunities</p> <ul style="list-style-type: none"> • Can thrive as open source alternative • No cheap alternative on the market 	<p>Threats</p> <ul style="list-style-type: none"> • Arsenal, an artificial intelligence wireless remote • Case Air, a more professional grade wireless remote

Figure 9: SWOT analysis for the product

3.2 Designing the product

In the design phase, some things are to be considered; The circuitry must be arranged in as small of an area as possible so that the case then can also be as small as possible. The LightBlue Bean is roughly 45 millimeters by 20 millimeters, and the case would in the best-case scenario be a tight fit so that no additional fasteners would be needed, and so that it would be as non-intrusive on the camera as possible. The product would be battery powered, so a mechanism for replacing the battery is also a requirement. As the circuitry will determine the size and shape of the case to a very large degree, it will have to be designed to completion first, but since the logic behind the triggering mechanism is relatively trivial it will likely not need any change after it is soldered on.

3.2.1 Designing the circuit

Comparing the products found in the market research, a couple of important things become apparent. To create a good base for the first iteration some requirements for the circuit would be:

1. Allow the microcontroller to trigger the camera shutter.
2. As cheap as possible.
3. As small of a footprint as possible.
4. As reliable as possible

The camera shutter will trigger on a roughly 5-volt circuit and to protect the microcontroller (which can operate anywhere between 2 and 5 volts, depending on the microcontroller) an optocoupler is used. Optocouplers, also known as optoisolators, isolate two circuits from each other, which allows for mixed voltages to be used within one system. The optocoupler contains an

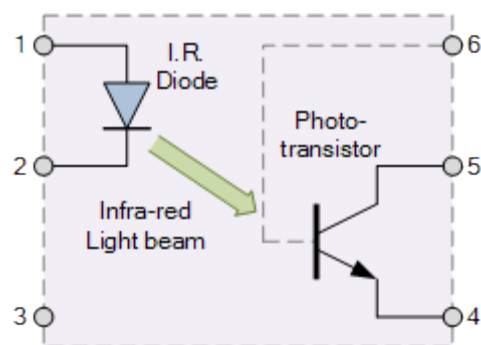


Figure 10: Optocoupler circuit diagram [45]

infra-red emitting LED on one side and a photo-sensitive detector transistor on the other side, which enables current to flow between pins on the other side. This is all packaged

in a small plastic case and has pins coming out from both sides which connects to the circuit. In this case, since all that needs to happen is that current must flow from one pin to another for the camera shutter to release the optocoupler is a perfect alternative. [45] The target camera in this experiment is a Nikon D700, which has a 10-pin connector (Figure 11). The three pins that are of interest are:

- Pin 4, the shutter release control
- Pin 6, ground
- Pin 9, Autofocus/meter ON

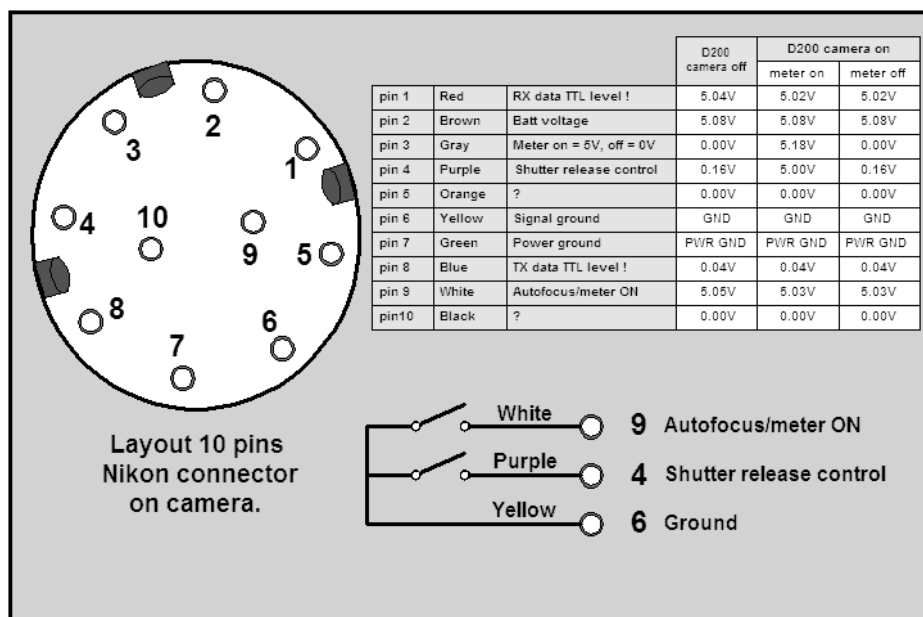


Figure 11: 10-pin connector layout for Nikon cameras, with a diagram of the basis for remote triggering and voltage readings and purpose of the pins [46]

For the camera to trigger, both pin 4 and 9 must be connected to ground (pin 6). If only the autofocus pin is connected, the camera engages the autofocus, and if only the shutter release pin is connected the camera refuses to take photos without autofocus giving the green light unless the autofocus is turned off on the camera. One optocoupler could connect both pins to ground, but with two optocouplers, one for the focus and one for shutter, more granular control of the camera operation is achieved; The focus can be triggered without taking a picture, and the shutter can be triggered if the focus is already completed using external help and can trigger multiple times instantly instead of waiting for the camera to find focus every time the shutter is triggered. The circuit can then be very trivial. Only two optocouplers must be soldered on, with some correct wiring as well.

This makes for a very small circuit that most likely will even fit on the small built-in protoboard on the LBB. Using a breadboard (a solderless board that is designed to quickly and temporarily test circuit designs), the validity of the design can be established.

The circuit makes use of the digital out pins on the LBB, which can either be input or output and read and write a HIGH or a LOW value. The values can be read as on and off for easier apprehension. This digital out pin leads to the optocoupler and returns to the LBB ground pin after going through the optocoupler. On the gated side of the optocoupler, the focus or shutter can then be connected. Both grounds lead to the same pin on the camera connector.

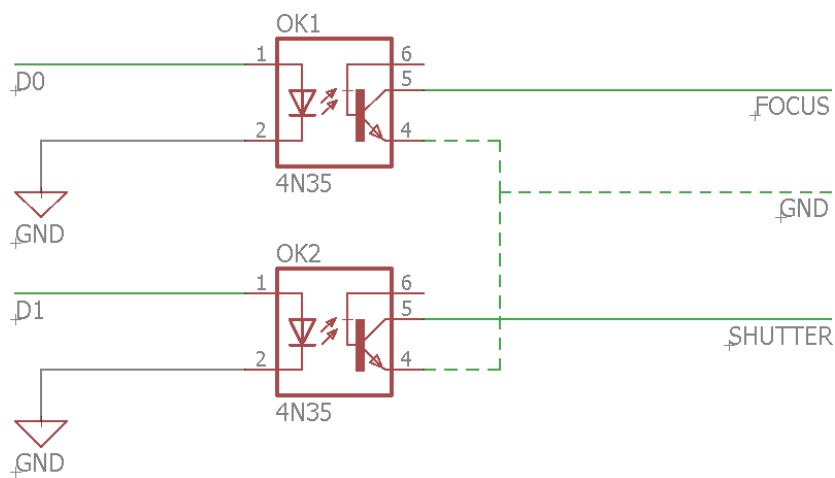


Figure 12: Circuit diagram, digital out 0 and 1 (D0 and D1 respectively) provides current from the LightBlue Bean, triggers the optocouplers, which in turn then lets the current flow for the focus and shutter to trigger

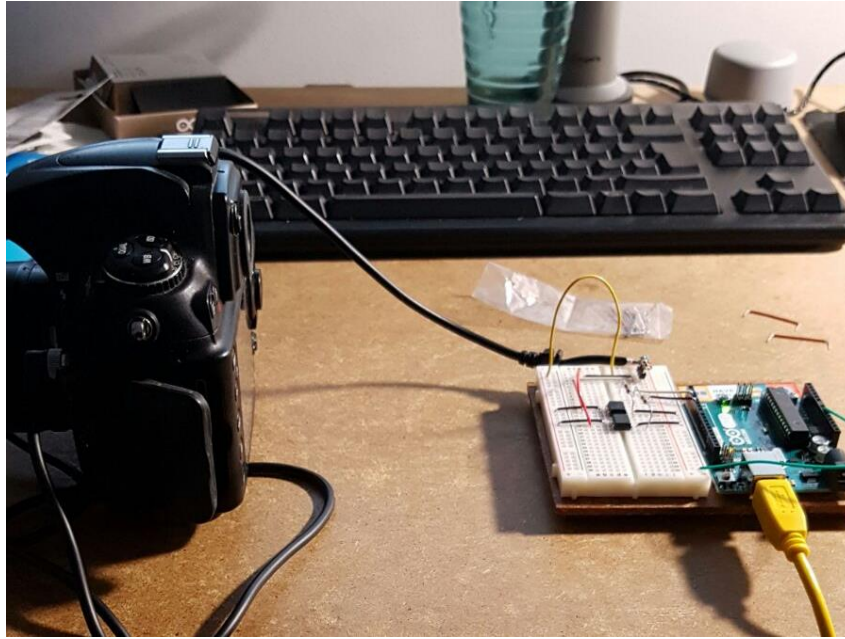


Figure 13: Using a breadboard and an Arduino microcontroller to design the circuitry.

3.2.2 Designing the case

The comparable products on the market differ in size and design, but to differentiate from them, the design requirements for the case could be:

1. Protect the circuit and hold the cable in place.
2. The battery compartment should be accessible.
3. The case should slot into the shoe on the camera.
4. As small as possible.
5. Cost-effective to manufacture.

Designing of the case happens in SolidWorks, a solid modeling computer-aided design program. From SolidWorks, a 3D-file can be generated that software provided by 3D-printer manufacturers can interpret and then slice layers and generate the G-code for the 3D-printer.

Attaching the case to the camera should be on top of the camera using a hot shoe that is available on most cameras. The hot shoe is an ISO standard part, so once the part fits, it should fit on any camera manufactured in the last 50 years. Ideally, the foot should also be of some sort of metal as it will be subject to a lot of wear, but since that is above the scope of this experiment, the foot will also be 3D printed. [47]

The parts of the design that will notice the most stress is the foot and any latches. These need extra attention as the development progresses and are most likely to break in the prototype.

To test what would be more suitable for this product, two slightly different case concepts are designed. The first has an internal latch and requires the user to press the cover so that the latches open and the top can be pulled off, but can be uniform in shape around the case, and is more minimal in its design. The other design is a more functional design, with the latch being external, with a small holding tab on the other side to keep the cover steadfast. The second case is more functional and perhaps easier to use than the first design. Both rely on a snug fit of the LBB inside the case, in such a way that no other attachments are needed for the circuitry to not move on the inside. Quickly the first concept is scrapped as the second one is much easier to print. The second concept was also heavily inspired by the LightBlue Bean enclosure by user “jwags55” found on Thingiverse.com [48], and such seems like a sounder option. The case will be created from scratch in SolidWorks, with only visually referencing the enclosure found on Thingiverse.com.

To achieve a proper fit around the LBB, the 3D model was imported from Punch Through Designs website [42] and added to the assembly file. A new part was created from the assembly file, and the outline of the LBB was copied into a sketch and offset by 2 millimeters outward, and then extruded 7,67 millimeters into to the bottom half of the case. The object was then shelled, with 1,9 millimeters wall thickness. The profile on both ends of the case was created by first adding material to one end by extrusion, and then cutting away parts of it by lofts instead of numbers and then mirrored to the other side. Lastly, for the bottom part, a hot shoe mount was created by extruding a 16- by 18- millimeter block out by 8 millimeters on the underside and then cutting out the two slots on each side.

The upper part of the case is then created, again from the assembly. Referencing the outline of the bottom part in a sketch, the general shape is then extruded up by 5 millimeters. A one-millimeter thick lip around the whole part is then extruded, that extends over the bottom part by one millimeter. The end tab is then extruded on one end and shaped to fit the bottom part by removing material from the assembly view and referencing the bottom. A cavity is made for the board to sit in, using the LBB’s outline and then cutting into the part up to 2 millimeters from the top. A small support beam is

added above the Bluetooth SoC, to hold down the LBB more when the case is shut. The edges are then rounded on both the bottom and top part.

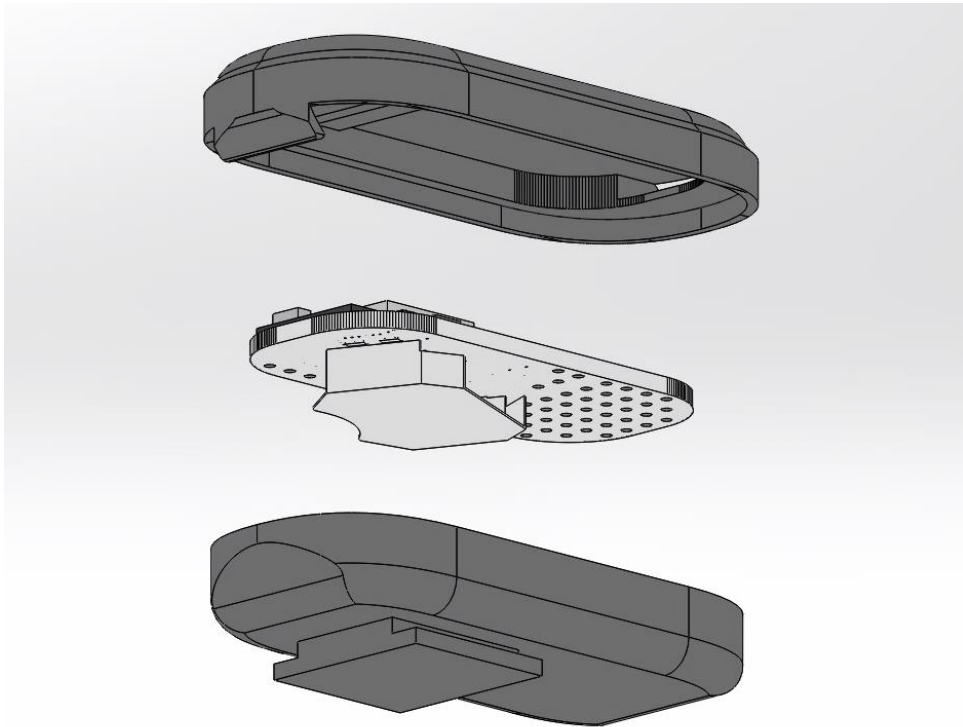


Figure 14: The case, with the LightBlue Bean inside of it, exploded in the assembly view inside SolidWorks.

3.2.3 Designing the software

As the main feature in direct contact with a user will be the software, through controlling the device, and the feature that can be endlessly improved and iterated upon, a few requirements for the software are established to create a simple but effective scope for this project:

1. Fine control for triggering the focus and shutter separately.
2. Accept communication over Bluetooth.

The software is developed within the Arduino ecosystem, using their integrated development environment. The language used is like a dialect of the programming language C++. Using the software that Punch Through Design provides, the code (or sketch as the Arduino program calls the code that is developed) can be then uploaded over

Bluetooth to the LBB. This makes it possible to iterate over the software while the LBB is in its case, attached to the camera.

The structure programs in an Arduino system is as follows: A function called setup (code line number 8, appendix 1) contains any initialization of any feature that you will need and parameters that need to be on a specific value at the start. This setup function is run only once, as the device is powered on. The loop function (line 15) contains your main running code, and it loops through the code inside of the function until the device is turned off. The loop speed is not a constant, as it is dependent on how much code there is to execute. In this case, the setup contains the modes for the digital pins, as they can both receive and send data, and the initialization of the pins so that they are not active.

Lines 4-6 initializes variables. The two first variables are the pin numbers established in so that it is easier to read what is being activated. The last variable is related to Bluetooth communication, which comes in later.

The setup function establishes first that the pins are for output only, and after that ensures that there is no current running in the pins, establishing a baseline.

The loop function is doing two things; It is looking out after changes in a scratch characteristic data point and if the data has been changed then triggers the camera. Scratch characteristics are a low-level form of communication where a data point is stored on the device (i.e. a characteristic variable) with a unique address, that is readable and writable by external devices, over Bluetooth [49]. In order to tell the device that it should trigger the camera, any value above 0 will then allow the if statement to run. Within the if statement the LED is turned on to signal that the device got the command, and the pins are triggered so that the camera has time to focus, before taking a picture. The LED is then turned off and the scratch characteristic is then overwritten to 0, so that only one picture is taken.

3.3 Iteration process

After the first design phase, the first prototype is built. In the building phase, multiple unexpected issues occur and are fixed in order to finish the build. These issues are things that only come to light when the plan is set to motion when theory meets practice. After the first parts are built, enough feedback has accumulated that the iteration process can begin for the product.

3.3.1 Circuit

The circuit planned in figure 7 was modified slightly. Since the area of the protoboard on the LBB is so small, the digital outputs had to be changed from D0 and D1 to D1 and D4 respectively. This changes nothing in the software side, except for the variables. The circuitry is simple but connecting the camera cable to the LBB required some thought. One alternative was to solder the leads on to the board directly, but this would make modifying cables and removing the LBB from its case much more difficult. A connector was then considered and effectively implemented. A simple 2.54-millimeter one row 4-pin connector was chosen for its small footprint and easy adaptability. The cable connecting the camera and the LBB is taken from a manual wired remote trigger and shortened. The leads for the female connector are crimped on to each of the three wires in the cable.

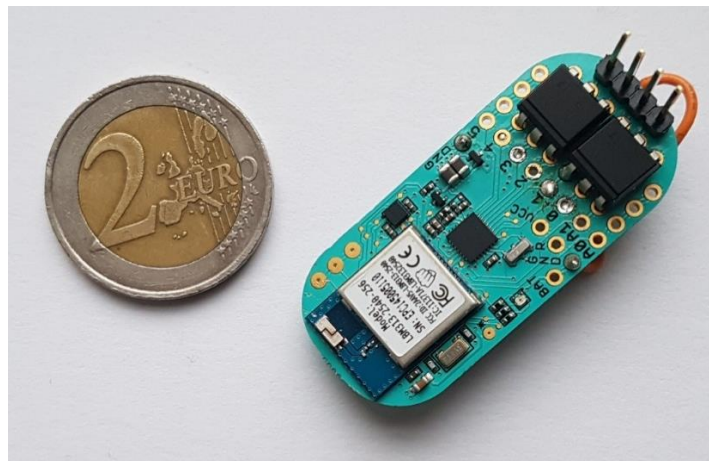


Figure 15: The circuit soldered on to the LBB, a 2-euro coin for scale

3.3.2 Case

Since the cases were designed without a connector in mind, the hole for the connector must be implemented. The connector is put on the upper part of the case, in connection with the internal ceiling. The connector also serves a secondary purpose on holding the LBB quite firmly in place, although it does not see a lot of stress since the LBB already sits very snugly within the case.

Another small feature is considered: A hole that allows for the LED to shine through, but this is proven to be unnecessary as the LED shines through the white PLA even at full thickness.



Figure 16: The three iterations of the upper part of the case that changed the most

The two parts of the case were printed and evaluated. The fit was not proper and the circuit board was changed, which leads to that the case was not properly designed either. The tab which holds the upper part (the darker part in Figure 18) in place was too large and had to be shortened by a few millimeters, and the lip keeping the upper part in place was lengthed by 2 millimeters to improve the latching mechanism. The shelling operation was also expanded by 0.2 millimeters so that the LBB would fit more effortlessly. To improve the feel of the part, all corners were given a 3 mm round fillet. The hot shoe mount was a nice and tight fit, so no modifications were needed there.

The connector was fitted in the upper part of the case, and a 2,3 by 10,3-millimeter hole was cut into it. The initial print showed that some extra width was necessary for a more suitable fit, as the printing accuracy is high enough to create too tight of a fit when creating holes that are precise.

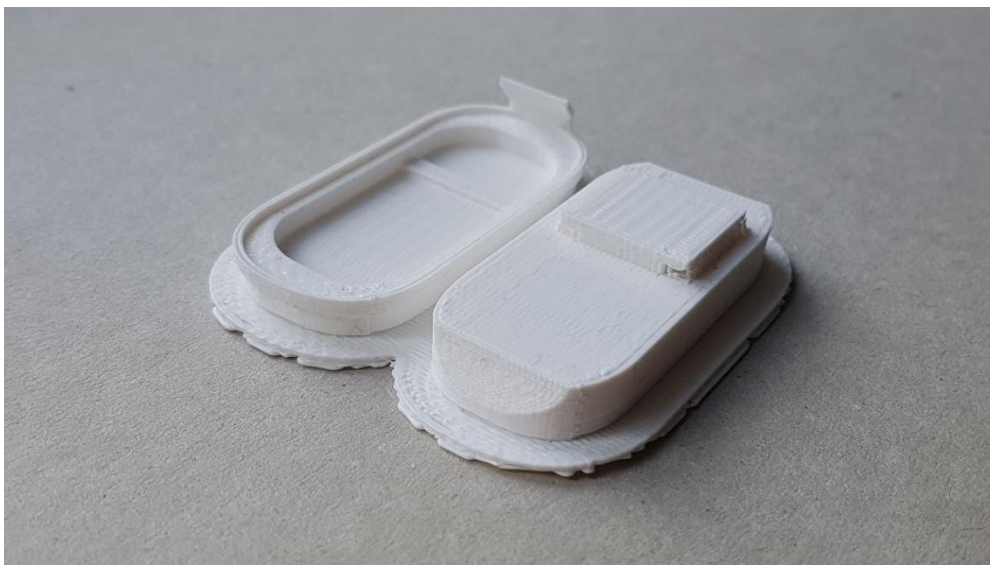


Figure 17: First iteration of the case design, straight from the printer with no post-processing done

The upper part was then iterated over again and reprinted. This resulted in the final form and prototype part of the case. In order to fit the LBB, the upper part had to be taller, and the location of the connector pins was realigned so that the pins naturally extend out from the hole. The hole was also enlarged, as not to make the connector fit too tight.

The holding tabs on all three top parts that were printed resulted in quick failure. This was partly because of the nature of the FDM printing, as the layering was oriented in such way that the part was placed on top of the rim, and not integrated properly into the rest of the case. Using an SLA printer could perhaps have avoided the issue, but since for this prototype the tab seemed to provide only a little bit of support, the issue was ignored, and considered non-important for this particular experiment.

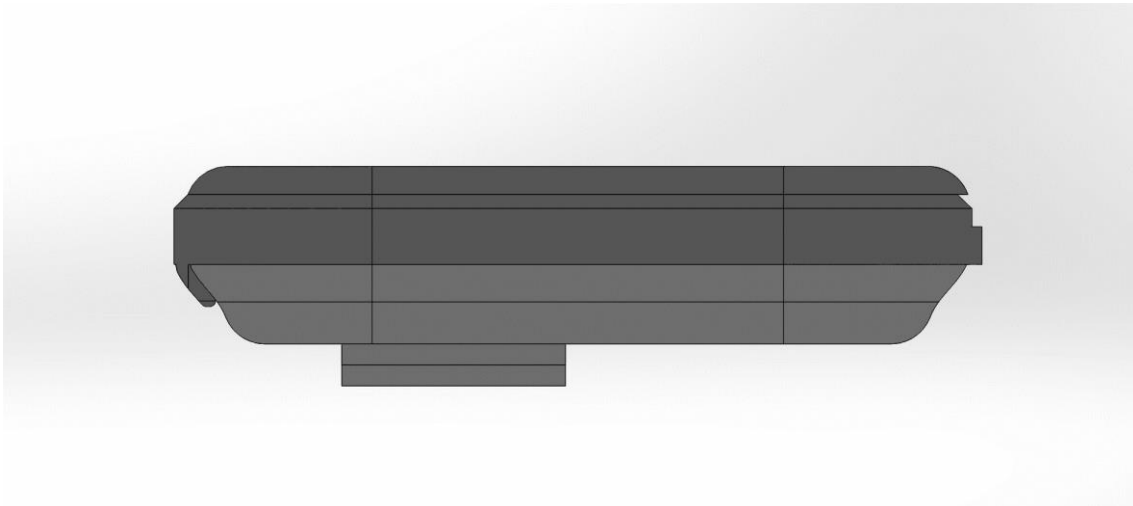


Figure 18: The case in SolidWorks

3.3.3 Software

The software was not changed as it was working adequately. A custom mobile application was considered but then concluded that it was out of the scope of this thesis. A rough draft was done for the phone in Android Studio, but no additional time was put into it.

3.4 Production

To create the layers for the FDM to print the part, MakerBot's own Print program was used. The two halves of the case were then placed out on the printing surface in the

program to minimize the footprint. The upper part of the case was easy to realize which side would be up for the print to work. The lower part required more thought, with a precision part on one side and a cavity on the other. In the end, the hot shoe connector required more precision, so minimal amounts of support structures created a more accurate print. The program automatically added the supports, but the default settings for printing did not add support for the hot shoe connector, or on the cavity. This was solved by enabling the “Supports” option, under the “Supports and Bridging” sub-menu. The rest of the options were left untouched. The software gave an estimation of 1 hour and 13 minutes, and approximately 16 grams of polylactic acid (PLA) was to be used. The print was then initiated and was completed in 1 hour and 11 minutes¹. The support structures were then removed, using knives and pliers. The surface finish was not ideal, but very capable of showing the core idea of the product, so no additional post-processing was deemed necessary.

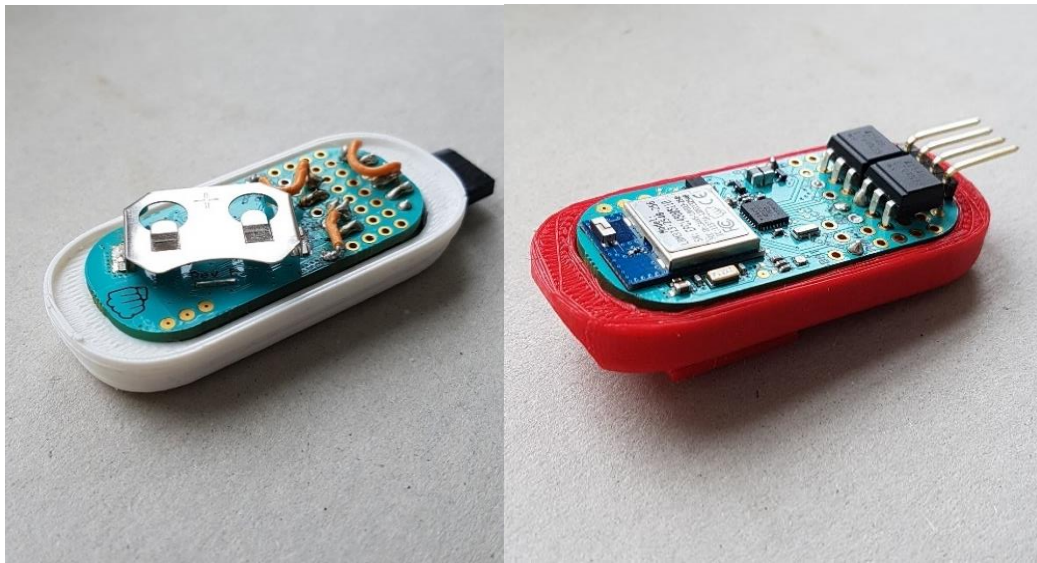


Figure 19: The final product, opened. Bottom part is on the left and top part on the right

¹ It is possible that the software included the pre-print routine in the estimate, in which case the complete printing time was the same as the estimate.

4 RESULTS

The research questions laid out in the introduction can then be evaluated and discussed in this subsection. The questions asked were:

RQ1: Can the product development technique “minimum viable product” be used for hardware projects in the same manner as it is used for software projects?

RQ2: What are the available tools for making a small hardware project?

RQ3: How do you iterate on hardware?

Answering the first research question, this thesis and the literature overview for MVP in hardware shows that there clearly is a possibility to use the development technique in such a way that you can follow its principals. The iteration cycle is not nearly as fast as it can be in its software state, but these are the realities of making a physical product. Manufacturing has always been a time-consuming process, but with the aid of modern manufacturing methods, the time it takes to have a working prototype to evaluate has been improved by a large margin.



Figure 20: The finalized product, seated in the hot shoe on a camera. The cable goes from the product to the camera remote socket

This then leads to the second question, where the tools quite clearly become defined in this thesis. Additive manufacturing (or rapid prototyping) has improved significantly

since their introduction to the manufacturing world and become much cheaper in the same process. This leads to the realization that anyone could with minimal effort and costs produce a quick prototype for an idea, without the need to create everything from scratch. The different additive manufacturing methods also make it so that if one method proves to be bad for that product, most likely another method will not have the same difficulties. For electronics, the Arduino project has helped to create an easy-to-access and cheap way for the complete beginner to create something with microcontrollers and automation, and with their open source mentality have made it possible for even more niche products to emerge based on the platform, with the LightBlue Bean as a prime example of this. The last question is answered by the small project completed for this thesis. The largest iteration and most demanding part was by far the case, which had to be printed and iterated upon multiple times. But again, the methods available creates an easy way of discovering just what is wrong and how to remedy it in the designs. Being able to physically inspect the product in its prototype stages actually may make it easier to define the next milestone which then can be completed quickly by just changing some parameters on the designs. The accurate reproduction of the 3D-printing also inspires confidence in that what you create in your CAD-software is going to look similar when you get it in your hands. Defining the requirements of each part also help to keep the product more focused and limits the possible scope of the project. The final product can then also be compared to the original idea (Table 1) and can also be used as a tool for learning how designing for the real world differs from just making digital designs that never get made.

Table 1: Table of requirements as stated in the designing phase and the results of production

Part	Original requirements	Final features
Circuit	<ul style="list-style-type: none"> • Allow the microcontroller to trigger the camera shutter. • As cheap as possible. • As small of a footprint as possible. • Reliable 	<ul style="list-style-type: none"> • By giving signal to the right pin the focus or shutter triggers. • Costs are tied to the microcontroller, rest of circuitry is only roughly a percentage of the price • No additional boards needed other than the LBB • Simple circuitry creates a reliable product

Case	<ul style="list-style-type: none"> • Protect the circuit and hold the cable in place. • The battery compartment should be accessible. • The case should slot into the shoe on the camera. • As small as possible. • Cost-effective to manufacture. 	<ul style="list-style-type: none"> • Holds the LBB in place and the cable connector, instead of the whole cable. • The LBB is removable so by extension the battery compartment • Slots on to the hot shoe. • The case was 3D-printed. • Is a snug fit around the
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Software	<ul style="list-style-type: none"> • Fine control for triggering the focus and shutter separately. • Accept communication over Bluetooth. 	<ul style="list-style-type: none"> • Can only trigger both focus and shutter at the same time, for simplicity • Can receive commands over Bluetooth
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5 DISCUSSION

The overshadowing limitation of this thesis is the scope. A longer timeframe and more funding and drive to create a product that is released to the market would have generated very interesting topics that could be further developed. This limitation creates a situation where the product is by all definition a “minimum viable product” but is not a “minimum sellable product”. The project served its purpose in this thesis, but to gain any real data, more development time is needed, and its features improved, like the case which is functional but not user friendly in any sense, or the microcontroller that does not contain any energy saving functionality, which means it drains the battery fast, as soon as the battery is attached.

The lack of consumer feedback is also a large segment that is missing from the iteration process. A real product would have been introduced to a select few in the consumer photography market segment, who would, in turn, use the product and give essential information about what they are expecting of the product. This dialogue between the manufacturer and consumer is the most valuable asset that any company that is developing a product can have, and the scope of this project limits itself so that it never gets to that phase of development.

Further research could also be done on scaling production up, as in what steps are to be taken from the final test prototype to the first production prototype. Any mass production is most likely not viable to 3D-print, and more robust and quicker ways of creating parts have to be developed. Injection molding would be the most likely option for this production, as the parts are small and could be modified to make an even simpler mold. The LightBlue Bean also contains a plethora of useless features for this project, like temperature sensors and accelerometers, so making the circuitry smaller would also create an even smaller product, and the iteration process would continue.

Furthermore, a large study of real-life products and their initial development would be very interesting to conduct, from the ideation to creation of the finalized product, and then the life cycle, and evolution, of that product after it has been created. As an example, the development of the iPod by Apple, or the Nest thermostat by Nest Labs.

6 CONCLUSIONS

Producing a hardware product is challenging and requires a firm desire to introduce something special to the market. By avoiding common pitfalls of development (over thinking and generalizing the product too much) the challenges can be reduced by a fraction, but the main issue is still the time it takes to iterate over something so intricate as how a product feels in your hand. This is something that you cannot see on a screen or on paper, it is something that requires a multitude of tests and modifications. The scope of this thesis does not allow for too many iterations of the design as required, but still provides a valuable lesson in designing physical products. Rapid prototyping technologies provide a solution, but it cannot reach the same elasticity of software development where you can have hundreds of different versions over a week of development. These are but the harsh realities of producing hardware to the market.

The minimum viable product development method as is does not support the hardware development procedures. But by taking the core principles and modifying them, a more suiting work model can be discovered:

1. Do one thing and do it well.

By focusing on one feature (in the example in this thesis, trigger a shutter on a camera) makes it more likely that the feature is relevant. In comparison if you would make a product that can take the picture, modify it, upload it to a cloud service and edit it, how many would perhaps just use it for the first feature? With one feature you guarantee that the customers that buy that product want it for one reason, which then gives you good feedback on what to develop next.

2. Engage customers and listen to them.

Developing features with a metaphorical blindfold on creates situations where you do not know if a feature is relevant. Perhaps the customers do not think that some feature that you spend a lot of time on is that essential for the function of the product, thus making you essentially waste time unnecessarily.

3. Use the prototype for extended times.

Avoiding rushing the product to production before it feels right will vastly improve the usability and life time of the product. A lot of issues and use cases do not occur until extended use. Money is always an issue, but it's better to have a good product on the market than something that is falling apart, and no one will invest in.

4. Try thinking on a smaller scale.

Since scaling hardware is much harder than scaling software, focusing on a smaller market or scale keeps the production cost down. The unit price for manufacturing will go down with larger orders but selling out the stock and not having the product immediately available might even create a larger desire for the product if it impresses users. Smaller orders can even be locally produced, instead of going to a mega-factory in one of the production countries, creating an ecological advantage as well, and less cost for moving the product from factory to warehouse. The pressure to produce something to sell worldwide does more damage than opportunities, with many of the

large companies that are dominating the market today either have started from producing something completely different from the product they sell today or started on an extremely small scale. It is easier to scale production up on local success than it is to ramp it down after a failure.

These four principals were named the Edmund principles² and demonstrate a new way of thinking when it comes to building a product, modified from the minimum viable product institution that is the dominating thinking process on the market at this time. These principles promote longevity instead of instantaneous profit, and sustainability instead of mindless consumption. Hardware *is* hard, but with rapid prototyping and an era of unlimited knowledge and resources, it does not have to be impossible.

² In memory of my late grandfather

7 ABSTRAKT

Detta slutarbete undersöker ifall produktutvecklingsteorin "minimum viable product" (direkt översatt till enklaste gångbara produkten, förkortat till MVP), som oftast används inom programvaruutvecklingsindustrin, kan användas för utveckling av fysiska produkter. Bakgrunden till detta experiment kommer från den svåra marknaden som nya företag hamnar i, ifall de försöker introducera nya fysiska produkter. Även när företagen får investeringar visar statistiken att upp till 70% av företag går i konkurs.

Intressanta hjälpmedel har dykt upp på marknaden de senaste fem åren, som underlättar utvecklingsprocessen. Friformsframställning och mikrokontrollerkort har utvecklats till kraftiga verktyg som produktutvecklaren kan använda för att snabbt skapa en prototyp och få konstruktiv kritik om vad produkten kan behöva för att bli en succé.

I litteraturöversikten går slutarbetet igenom tre stora områden: Friformsframställning, MVP och mikrokontrollerkort. Friformsframställning är ett så stort område, vilket leder till att endast de tre grundläggande och mest sannolika alternativen väljs för närmare granskning. Metodiken och för- och nackdelar förklaras för varje alternativ. Basprincipen för friformsframställning är den samma; ett datorprogram skär den tredimensionella modellen till tunna skivor, vilka då kan printas ut på varandra, lager för lager, för att skapa en tredimensionell produkt. Hur lagren produceras varierar sedan.

Stereolitografi (SLA) är den första moderna friformsframställningstekniken som utvecklades redan på 80-talet. Materialet flyter i en behållare, och en laserstråle härdar ett lager av modellen till en byggplattform. Beroende på modellen för maskinen så sjunker eller lyfts byggplattformen sedan, och nästa lager härdas, och så vidare, tills alla lager har härdats. Objektet måste sedan härdas färdigt, för processen härdar inte lagren fullständigt. Detta ger mera styrka mellan lagren för de kan forma bindningar i alla riktningar.

Selective Laser Sintering (SLS) baserar sig mycket på samma koncept som stereolitografi, men istället för att ha materialet i flytande form, är det pulver istället. Pulvret är uppvärmt i en behållare och en laserstråle smälter och därmed sintrar pulvret till en homogen del. Byggplattformen sjunker, och ett tunt lager av pulver läggs på och processen upprepar sig. Pulvret kan återanvändas men lider ifall de värms upp ett flertal gånger och därmed blir oanvändbart. Pulvret stöder objektet medan de printas, vilket

betyder att inga stödstrukturer behövs, men ytan blir porös, och lagren förblir synliga, för de inte formar extra bindningar mellan lagren.

Fused Deposit Modelling (FDM) är den mest populära metoden för friformsframställning. Metoden använder minst möjliga mängd material, och lägger materialet ut på byggplattformen genom extrudering ur ett uppvärmt munstycke. Materialet kyls snabbt ner på grund av temperaturskillnaden, och stelnar på plattformen, och nästa lager kan direkt läggas ut. Stöd behövs endast om objektet har hängande delar, och oftast hjälper det att vända på objektet. Likt SLS så förblir lagren synliga, men ytorna är inte porösa och med hjälp av efterbehandling kan ytan bli slät ifall det behövs.

Minimum viable product är en teknik som Frank Robinson introducerade år 2001, men blev populär med Eric Ries book "The Lean Startup" år 2011. Konceptet går ut på att istället för att gissa vad kunder behöver, och vill ha, så introduceras de till produkten så snabbt som möjligt. Ries kallar dessa kunder till "visionärer", för de ser inte produkten endast hur den fungerar och ser ut i början, utan vad den kan uppnå efter längre utveckling. Dessa kunder accepterar en sämre produkt för de vill delta i produktutvecklingsprocessen genom att ge kritik. Genom att engagera kunder tidigt i processen, klarar man av att skärpa sitt fokus mot den mest väsentliga delen av produkten. Processen sköts igenom att iterera, i en evig cykel. Från att lösa ett problem till att bygga en prototyp, som kunder engageras med och ger kritik, och tillbaka till att lösa de problem som uppstod från kritiken.

Mikrokontrollrar är fullständiga kretskort, med processor, minne och programminne, integrerade på en och samma kiselbricka. Ett mikrokontrollerkort är sedan nästa steg från detta, där allting som behövs för att kommunicera med mikrokontrollerna är kopplade till större och enklare in- och utgångar, som till exempel USB. Mikrokontrollerkort är därmed ett verktyg för att experimentera och snabbt utveckla en liten produkt.

Som ett experiment utvecklas en produkt. Konceptet utgår från att äldre kameror inte har möjlighet att kommunicera trådlöst över Bluetooth, och med att tillverka en modul som hämtar den moderna funktionen till äldre modeller ökar man livslängden och användningsmöjligheten för kameror. En marknadsanalys och en SWOT analys utförs och två huvudsakliga produkter existerar på marknaden. Till slut delas produkten in till

tre delar (kretskortet, fodralet och mjukvaran) för att separera iterationsprocessen och underlätta utvecklingen. Produkten utvecklas sedan enligt MVP teorin, var varje del itereras över ända tills produkten blir användbar. De flesta iterationscykeln går till fodralet och dess form.

Experimentet tog slut efter att produkten var användbar. Detta leder till att MVP inte blev fullständigt utvärderat, p.g.a. att produkten aldrig visades till kunder. Problemet låg mera i tidsbrist än i fel i utvärderingssättet. MVP fungerar även med fysiska produkter, men man måste vara beredd att inte klara av en lika snabb itereringscykel. En större investering krävs, men med smartare tidsanvändning och mera intensivt fokus på att utveckla en produkt som gör en sak väl istället för att vara så mångsidig som möjligt. För att underlätta processen och fokusen skapades fyra punkter vars uppgift är att komplettera ideologin bakom MVP.

- 1. Gör en sak, men gör den väl.*
- 2. Engagera kunderna och lyssna på deras bekymmer.*
- 3. Använd prototypen för så länge det är möjligt.*
- 4. Försök tänka i mindre banor.*

Med dessa punkter kan jobbet för att skapa ett hållbart företag och en välgjord produktlinje bli enklare. Punkterna hyllar hållbarhet och tanken om att bra produkter tar en lång tid att utveckla.

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APPENDIX 1. remoteccontroller.ino

```
1. // remoteccontroller.ino
2. // Listens for any value above 1 from scratch 1
3.
4. int focus = 1;
5. int shutter = 4;
6. uint32_t scratch = 0;
7.
8. void setup() {
9.   pinMode(focus, OUTPUT);
10.  pinMode(shutter, OUTPUT);
11.  digitalWrite(focus, LOW);
12.  digitalWrite(shutter, LOW);
13. }
14.
15. void loop() {
16.
17.  scratch = Bean.readScratchNumber(1);
18.
19.  if (scratch > 0){
20.    Bean.setLed(50, 0, 0);
21.    digitalWrite(focus, HIGH);
22.    delay(1000);
23.
24.    Bean.setLed(100, 0, 0);
25.    digitalWrite(shutter, HIGH);
26.    delay(1000);
27.    digitalWrite(shutter, LOW);
28.    digitalWrite(focus, LOW);
29.
30.    Bean.setLed(0, 0, 0);
31.    Bean.setScratchNumber(1, 0);
32.  }
33. }
```